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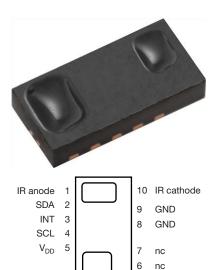
COMPLIANT

GREEN



Vishay Semiconductors

Fully Integrated Proximity Sensor with Infrared Emitter, I²C Interface, and Interrupt Function



DESCRIPTION

The VCNL3020 is a fully integrated proximity sensor. Fully integrated means that the infrared emitter is included in the package. It has 16 bit resolution. It includes a signal processing IC and features standard I²C communication interface. It features an interrupt function.

APPLICATIONS

- Proximity sensor for mobile devices (e.g. smart phones, touch phones, PDA, GPS) for touch screen locking, power saving, etc.
- Proximity/optical switch for consumer, computing and industrial devices and displays

FEATURES

- · Package type: surface mount
- Dimensions (L x W x H in mm): 4.90 x 2.40 x 0.83
- Integrated infrared emitter, proximity sensor, and signal conditioning IC
- Interrupt function
- Supply voltage range V_{DD}: 2.5 V to 3.6 V
- Supply voltage range IR anode: 2.5 V to 5 V
- Communication via I2C interface
- I²C Bus H-level range: 1.7 V to 5 V
- Floor life: 72 h, MSL 4, acc. J-STD-020
- Low stand by current consumption: 1.5 μA
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

PROXIMITY FUNCTION

- Built-in infrared emitter and photo-pin-diode for proximity function
- 16 bit effective resolution for proximity detection range ensures excellent cross talk immunity
- Programmable LED drive current from 10 mA to 200 mA in 10 mA steps
- Excellent ambient light suppression by signal modulation
- Proximity distance up to 200 mm

| PRODUCT SUMMARY | | | | | | | | | |
|-----------------|----------------------|-----------------------------------|--|----------------------------------|--------------------------|--|--|--|--|
| PART NUMBER | OPERATING RANGE (mm) | OPERATING VOLTAGE RANGE (V) | I ² C BUS VOLTAGE RANGE (V) | LED PULSE CURRENT (1) (mA) | OUTPUT CODE | | | | |
| VCNL3020 | 1 to 200 | 2.5 to 3.6 | 1.7 to 5 | 10 to 200 | 16 bit, I ² C | | | | |

Note

(1) Adjustable through I²C interface



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| ORDERING INFORMATION | | | | | | | | | |
|----------------------|---------------|-----------------|--------------------------------------|--|--|--|--|--|--|
| ORDERING CODE | PACKAGING | VOLUME (1) | REMARKS | | | | | | |
| VCNL3020-GS08 | Tape and reel | MOQ: 3300 pcs | 4.90 mm x 2.40 mm x 0.83 mm | | | | | | |
| VCNL3020-GS18 | rape and reei | MOQ: 13 300 pcs | 4.90 Hilli x 2.40 Hilli x 0.63 Hilli | | | | | | |
| VCNL4000demokit (2) | - | MOQ: 1 pc | - | | | | | | |

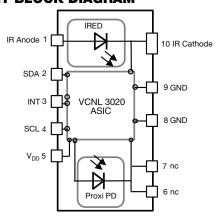
Notes

- (1) MOQ: minimum order quantity
- (2) VCNL4000 demokit provides USB dongle, basic software including Vishay licence. The VCNL3020 sensor board could be ordered free of charge. For your order please contact sensorstechsupport. Software updates for VCNL3020 could be downloaded from web site: www.vishay.com/optical-sensors/list/product-83476/

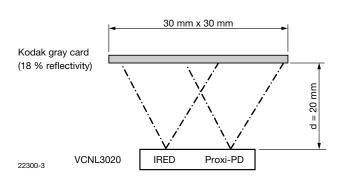
| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | | | | |
|--|--------------------------|------------------|-------|------|------|--|--|--|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | MAX. | UNIT | | | | | |
| Supply voltage | | V_{DD} | - 0.3 | 5.5 | V | | | | | |
| Operation temperature range | | T _{amb} | - 25 | + 85 | °C | | | | | |
| Storage temperature range | | T _{stg} | - 25 | + 85 | °C | | | | | |
| Total power dissipation | T _{amb} ≤ 25 °C | P _{tot} | | 50 | mW | | | | | |
| Junction temperature | | Tj | | 100 | °C | | | | | |

| BASIC CHARACTERIS | STICS (T _{amb} = 25 °C, unless o | therwise sp | ecified) | | | |
|--------------------------------------|---|------------------|----------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply voltage V _{DD} | | | 2.5 | | 3.6 | V |
| Supply voltage IR anode | | | 2.5 | | 5 | V |
| I ² C Bus H-level range | | | 1.7 | | 5 | V |
| INT H-level range | | | 1.7 | | 5 | V |
| INT low voltage | 3 mA sink current | | | | 0.4 | V |
| Current consumption | Standby current, no IRED-operation | | | 1.5 | 2 | μΑ |
| | 2 measurements per second, IRED current 20 mA | | | 5 | | μΑ |
| Current consumption | 250 measurements per second, IRED current 20 mA | | | 520 | | μΑ |
| proximity mode incl. IRED (averaged) | 2 measurements per second, IRED current 200 mA | | | 35 | | μΑ |
| | 250 measurements per second, IRED current 200 mA | | | 4 | | mA |
| I ² C clock rate range | | f _{SCL} | | | 3400 | kHz |

CIRCUIT BLOCK DIAGRAM



TEST CIRCUIT



Note

nc must not be electrically connected
 Pads 6 and 7 are only considered as solder pads

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

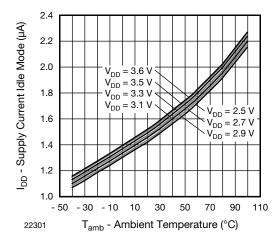


Fig. 1 - Idle Current vs. Ambient Temperature

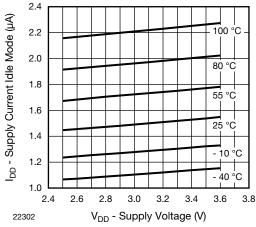


Fig. 2 - Idle Current vs. V_{DD}

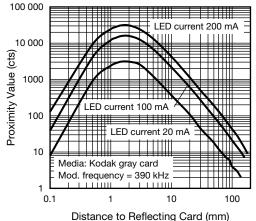


Fig. 3 - Proximity Value vs. Distance

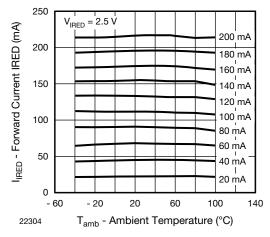


Fig. 4 - Forward Current vs. Temperature

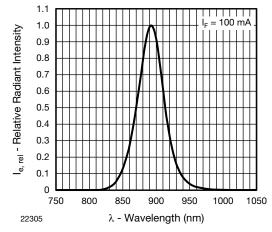


Fig. 5 - Relative Radiant Intensity vs. Wavelength

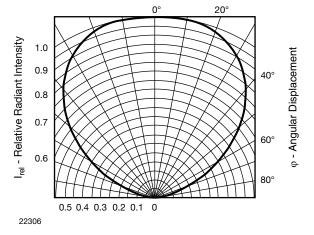
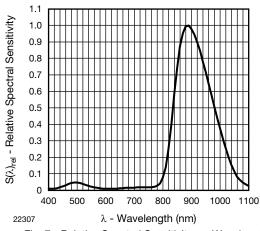
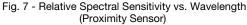


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement



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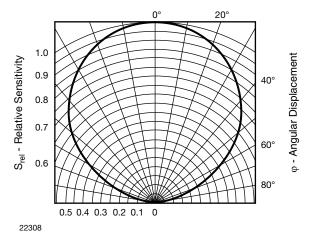


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement (Proximity Sensor)

APPLICATION INFORMATION

VCNL3020 is a cost effective solution of proximity sensor with I²C bus interface. The standard serial digital interface is easy to access "Proximity Signal" without complex calculation and programming by external controller. Beside the digital output also a flexible programmable interrupt pin is available.

1. Application Circuit

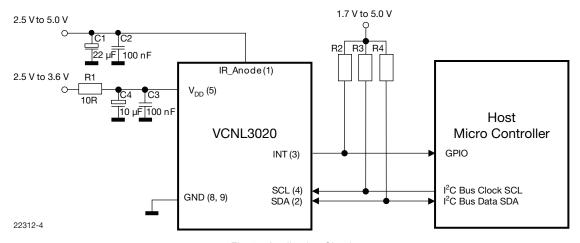


Fig. 9 - Application Circuit (x) = Pin Number

Note

The interrupt pin is an open drain output. The needed pull-up resistor may be connected to the same supply voltage as the application controller and the pull-up resistors at SDA/SCL. Proposed value R2 should be >1 kΩ, e.g. 10 kΩ to 100 kΩ.
 Proposed value for R3 and R4, e.g. 2.2 kΩ to 4.7 kΩ, depend also on the I²C bus speed.
 For detailed description about set-up and use of the interrupt as well as more application related information see AN: "Designing VCNL3020 into an Application".



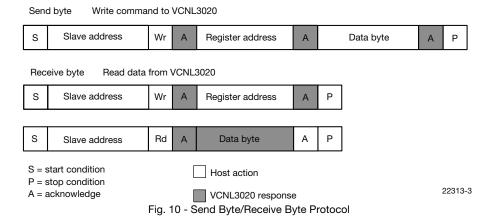
2. I²C Interface

The VCNL3020 contains seventeen 8 bit registers for operation control, parameter setup and result buffering. All registers are accessible via I²C communication. Figure 13 shows the basic I²C communication with VCNL3020.

The built in I²C interface is compatible with all I²C modes (standard, fast, and high speed).

 I^2C H-level range = 1.7 V to 5 V.

Please refer to the I²C specification from NXP for details.



Device Address

The VCNL3020 has a fix slave address for the host programming and accessing selection. The predefined 7 bit I^2C bus address is set to 0010 011 = 13h. The least significant bit (LSB) defines read or write mode. Accordingly the bus address is set to 0010 011x = 26h for write, 27h for read.

Register Addresses

VCNL3020 has seventeen user accessible 8 bit registers. The register addresses are 80h (register #0) to 90h (register #16).

REGISTER FUNCTIONS

Register #0 Command Register

Register address = 80h

The register #0 is for starting proximity measurements. This register contains a flag bit for data ready indication.

| TABLE 1 - | TABLE 1 - COMMAND REGISTER #0 | | | | | | | | | | |
|--------------------------------------|-------------------------------|--|--------------------|-------------------------|-------|-------------------|--------------|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | |
| config_lock | n/a | prox_data_rdy | n/a | prox_od | n/a | prox_en | selftimed_en | | | | |
| | Description | | | | | | | | | | |
| config_lock Read only bit. Value = 1 | | | | | | | | | | | |
| prox_d | ata_rdy | Read only bit. Value = 1 when proximity measurement data is available in the result registers. This bit will be reset when one of the corresponding result registers (reg #7, reg #8) is read. | | | | | | | | | |
| prox | c_od | | | nd measurement for read | | s #7(HB) and #8(L | .B). | | | | |
| prox | c_en | R/W bit. Enables | s periodic proximi | ity measurement | | | | | | | |
| selftim | ned_en | R/W bit. Enables state machine and LP oscillator for self timed measurements; no measurement is performed until the corresponding bit is set | | | | | | | | | |

Note

• Beside prox_en first selftimed_en needs to be set. On-demand measurement mode is disabled if selftimed_en bit is set. For the selftimed_en mode changes in reading rates (reg #2) can be made only when b0 (selftimed_en bit) = 0.



Register #1 Product ID Revision Register

Register address = 81h. This register contains information about product ID and product revision.

Register data value of current revision = 21h.

| TABLE 2 - | TABLE 2 - PRODUCT ID REVISION REGISTER #1 | | | | | | | | | | | |
|-----------|---|-----------------|-----------|-------------|-------|-------|-------|--|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | | |
| | Produ | uct ID | | Revision ID | | | | | | | | |
| | | | Descr | ription | | | | | | | | |
| Prod | Product ID Read only bits. Value = 2 | | | | | | | | | | | |
| Revis | sion ID | Read only bits. | Value = 1 | | | | | | | | | |

Register #2 Rate of Proximity Measurement

Register address = 82h.

| ABLE 3 - PROXIMITY RATE REGISTER #2 | | | | | | | | | | | |
|-------------------------------------|-----------|-------|---|--|-------|-------|-------|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | |
| | | n/a | | Rate of Proximity Measurement (no. of measurements per second) | | | | | | | |
| Description | | | | | | | | | | | |
| Proxir | nity rate | | easurements/s asurements/s surements/s surements/s | AULT) | | | | | | | |

Note

· If self_timed measurement is running, any new value written in this register will not be taken over until the mode is actualy cycled.

Register #3 LED Current Setting for Proximity Mode

Register address = 83h. This register is to set the LED current value for proximity measurement.

The value is adjustable in steps of 10 mA from 0 mA to 200 mA.

This register also contains information about the used device fuse program ID.

| TABLE 4 - | TABLE 4 - IR LED CURRENT REGISTER #3 | | | | | | | | | | | |
|-----------------------------------|--------------------------------------|--|-------|-------|-------|-------|-------|--|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | | |
| Fuse prog ID IR LED current value | | | | | | | | | | | | |
| Description | | | | | | | | | | | | |
| Fuse p | orog ID | Read only bits. Information about fuse program revision used for initial setup/calibration of the device. | | | | | | | | | | |
| IR LED cu | rrent value | R/W bits. IR LED current = Value (dec.) x 10 mA. Valid Range = 0 to 20d. e.g. 0 = 0 mA, 1 = 10 mA,, 20 = 200 mA (2 = 20 mA = DEFAULT) LED Current is limited to 200 mA for values higher as 20d. | | | | | | | | | | |



Register #7 and #8 Proximity Measurement Result Register

Register address = 87h and 88h. These registers are the result registers for proximity measurement readings.

The result is a 16 bit value. The high byte is stored in register #7 and the low byte in register #8.

| TABLE 5 - | TABLE 5 - PROXIMITY RESULT REGISTER #7 | | | | | | | | | | |
|-----------|--|-------|-------|---------|-------|-------|-------|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | |
| | | | Descr | ription | | | | | | | |
| | Read only bits. High byte (15:8) of proximity measurement result | | | | | | | | | | |

| TABLE 6 - | TABLE 6 - PROXIMITY RESULT REGISTER #8 | | | | | | | | | | |
|-----------|--|----------------|---------------------|--------------------|---------------|-------|-------|--|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | | |
| | Description | | | | | | | | | | |
| | | Read only bits | s. Low byte (7:0) o | of proximity measu | rement result | | | | | | |

Register #9 Interrupt Control Register

Register address = 89h.

| ABLE 7 | INTERRUPT | CONTROL R | EGISTER #9 | | | | | | |
|--|------------------|-----------------|--------------------|-----------------------|------------------|--------------|-----------|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| | Int count exceed | | n/a | INT_PROX_ ready_EN | n/a | INT_THRES_EN | INT_THRES | | |
| Description | | | | | | | | | |
| R/W bits. These bits contain the number of consecutive measurements needed above/bethreshold 000 - 1 count = DEFAULT 001 - 2 count 010 - 4 count 011 - 8 count 100 - 16 count 101 - 32 count 111 - 128 count 111 - 128 count | | | | | | below the | | | |
| INT_PRO | X_ready_EN | R/W bit. Enable | s interrupt genera | ation at proximity d | ata ready | _ | | | |
| INT_TI | HRES_EN | R/W bit. Enable | s interrupt genera | ation when high or | low threshold is | exceeded | | | |
| INT_THRES_SEL R/W bit. 0: thresholds are applied to proximity measurements | | | | | | | | | |



Register #10 and #11 Low Threshold

Register address = 8Ah and 8Bh. These registers contain the low threshold value. The value is a 16 bit word. The high byte is stored in register #10 and the low byte in register #11.

| TABLE 8 - LOW THRESHOLD REGISTER #10 | | | | | | | | | | |
|--------------------------------------|-------|-------|---------------------|---------------------|---------|-------|-------|--|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | | |
| | | | Descr | ription | | | | | | |
| | | R/W b | its. High byte (15: | 8) of low threshold | d value | | | | | |

| TABLE 9 - LOW THRESHOLD REGISTER #11 | | | | | | | | | | |
|---|---|--|--|--|--|--|--|--|--|--|
| Bit 7 | Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 | | | | | | | | | |
| Description | | | | | | | | | | |
| R/W bits. Low byte (7:0) of low threshold value | | | | | | | | | | |

Register #12 and #13 High Threshold

Register address = 8Ch and 8Dh. These registers contain the high threshold value. The value is a 16 bit word. The high byte is stored in register #12 and the low byte in register #13.

| TABLE 10 - HIGH THRESHOLD REGISTER #12 | | | | | | | | | | |
|--|---|--|--|--|--|--|--|--|--|--|
| Bit 7 | Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 | | | | | | | | | |
| Description | | | | | | | | | | |
| R/W bits. High byte (15:8) of high threshold value | | | | | | | | | | |

| TABLE 11 - HIGH THRESHOLD REGISTER #13 | | | | | | | | | |
|---|--|--|--|--|--|--|--|--|--|
| Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 | | | | | | | | | |
| Description | | | | | | | | | |
| R/W bits. Low byte (7:0) of high threshold value | | | | | | | | | |

Register #14 Interrupt Status Register

Register address = 8Eh. This register contains information about the interrupt status indicates if high or low going threshold exceeded.

| TABLE 12 - INTERRUPT STATUS REGISTER #14 | | | | | | | | | |
|---|---|-------|-------|-----------|-------|-------|-------|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| | n/a int_prox_ready n/a int_th_low int_th_hi | | | | | | | | |
| Description | | | | | | | | | |
| int_pro | int_prox_ready R/W bit. Indicates a generated interrupt for proximity | | | | | | | | |
| int_th | int_th_low R/W bit. Indicates a low threshold exceed | | | | | | | | |
| int_th_hi R/W bit. Indicates a high threshold | | | | ld exceed | | | | | |

Note

 Once an interrupt is generated the corresponding status bit goes to 1 and stays there unless it is cleared by writing a 1 in the corresponding bit. The int pad will be pulled down while at least one of the status bit is 1.

Register #15 Proximity Modulator Timing Adjustment

Register address = 8Fh.

| ABLE 13 - PROXIMITY MODULATOR TIMING ADJUSTMENT #15 | | | | | | | | | |
|--|--------------|---------------------|--------------------|---|------------|---------------------|--------------|--|--|
| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| Modulation delay time | | Proximity frequency | | Modulation dead time | | | | | |
| | | | Descr | ription | | | | | |
| Modulation delay time R/W bits. Setting a delay time between IR LED signal and IR input signal evaluation. This function is for compensation of delays from IR LED and IR photo diode. Also in respinosibility for setting different proximity signal frequency. Correct adjustment is optimizing signal level. (DEFAULT = 0) | | | | | | | | | |
| R/W bits. Settin | | z ` | | | | | | | |
| Modulation | on dead time | This function is | for reducing of po | evaluation of IR signs essible disturbance evel and should be | e effects. | of the IR signal. (| DEFAULT = 1) | | |

Note

The settings for best performance will be provided by Vishay. With first samples this is evaluated to:
 Delay Time = 0; Dead Time = 1 and Prox Frequency = 0. With that register#15 should be programmed with 1 (= default value).

Register #16 Ambient IR Light Level Register

Register address = 90h.

This register is not intended to be used by customer.

3. IMPORTANT APPLICATION HINTS AND EXAMPLES

3.1 Receiver standby mode

In standby mode the receiver has the lowest current consumption of about 1.5 μ A. In this mode only the I²C interface is active. This is always valid, when there are no proximity measurement demands executed. Also the current sink for the IR-LED is inactive, so there is no need for changing register #3 (IR LED current).

3.2 Data Read

In order to get a certain register value, the register has to be addressed without data like shown in the following scheme. After this register addressing, the data from the addressed register is written after a subsequent read command.

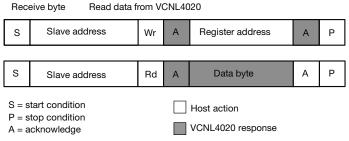


Fig. 11 - Send Byte/Receive Byte Protocol

The stop condition between these write and read sequences is not mandatory. It works also with a repeated start condition.

Note

For reading out 2 (or more) subsequent registers like the result registers, it is not necessary to address each of the registers separately. After
one read command the internal register counter is increased automatically and any subsequent read command is accessing the next
register.



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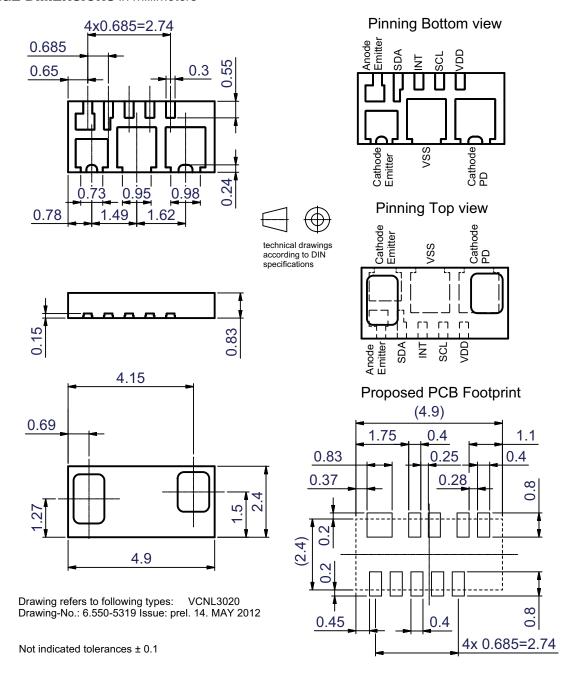
Example: read register "Proximity Result Register" #7 and #8:

Addressing:command: 26h, 87h (VCNL3020_I²C_Bus_Write_Adr., Proximity Result Register #7 [87])

Read register #7: command: 27h, data (VCNL3020_I²C_Bus_Read_Adr., {High Byte Data of Proximity Result register #7 [87])}

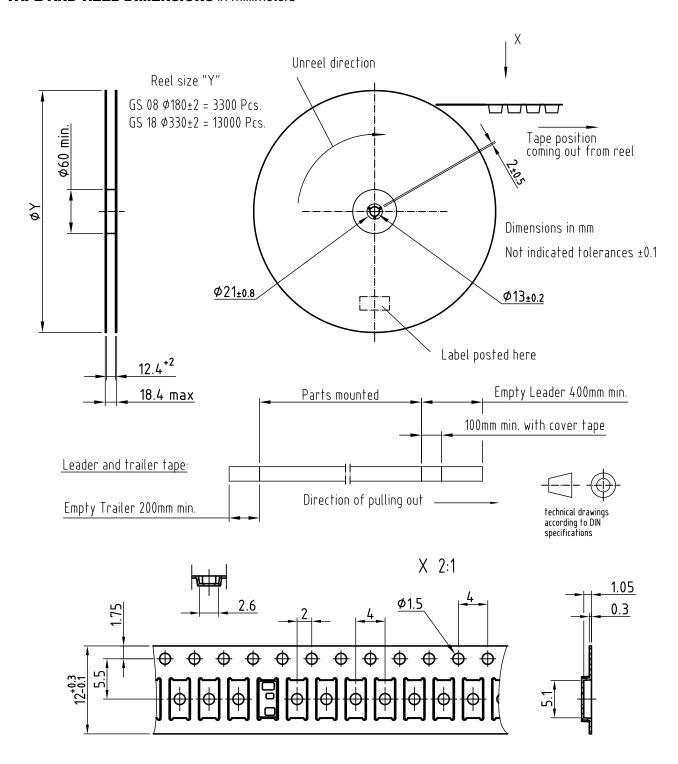
Read register #8: command: 27h, data (VCNL3020_12C_Bus_Read_Adr., {Low Byte Data of Proximity Result register #8 [88])}

PACKAGE DIMENSIONS in millimeters





TAPE AND REEL DIMENSIONS in millimeters



Drawing-No.: 9.700-5387.01-4

Issue: prel; 22.11.11



SOLDER PROFILE

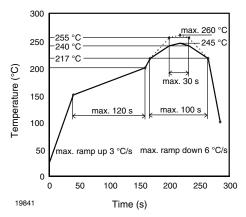


Fig. 12 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 72 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 4, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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Vishay

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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